SPECIFICATIONS FOR NICHIA UV LED

MODEL: NSHU590

NICHIA CORPORATION

1.SPECIFICATIONS

(1) Absolute Maximum Rating

 $(Ta=25^{\circ}C)$

| <i>y</i> | | • | () |
|----------------------------|--------|--------------------------|------|
| Item | Symbol | Absolute Maximum Rating | Unit |
| Forward Current | IF | 15 | mA |
| Pulse Forward Current | IFP | 50 | mA |
| Reverse Current | Ir | 85 | mA |
| Power Dissipation | PD | 60 | mW |
| Operating Temperature | Topr | - 30 ∼ + 85 | °C |
| Storage Temperature | Tstg | - 40 ∼ +100 | °C |
| Lead Soldering Temperature | Tsol | 260 ± 5 °C for 5sec. | |

IFP Conditions : Pulse Width ≤ 10 msec. and Duty $\leq 1/10$

(2) Initial Electrical/Optical Characteristics

 $(Ta=25^{\circ}C)$

| Item | | Symbol | Condition | Min. | Тур. | Max. | Unit |
|----------------------|--------|---------------------|------------------------|------|------|------|------|
| Forward Voltage | | VF | I _F =10[mA] | 1 | 3.5 | 4.0 | V |
| Peak Wavelength | | λP | I _F =10[mA] | 370 | 375 | 380 | nm |
| Spectrum Half Width | | $\triangle \lambda$ | I _F =10[mA] | 1 | 12 | - | nm |
| Optical Power Output | Rank 1 | Po | I _F =10[mA] | 425 | 500 | 600 | μW |
| | Rank 2 | Po | IF=10[mA] | 600 | 700 | 850 | μW |
| | Rank 3 | Po | IF=10[mA] | 850 | 1000 | 1200 | μW |

^{*} Measurement Uncertainty of the Optical Power Output : $\pm 10\%$

2.TYPICAL INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS

Please refer to figure's page.

3.OUTLINE DIMENSIONS AND MATERIALS

Please refer to figure's page.

Material as follows; Glass: Hard Glass

Cap : Ni Plating Iron Alloy Lead : Au Plating Iron Alloy

4.PACKAGING

Please refer to figure's page.

The label on the minimum packing unit bag shows;

Part Number, Lot Number, Quantity, Ranking

5.LOT NUMBER

The first six digits number shows **lot number**.

The lot number is composed of the following characters;

 $\bigcirc \square \times \times \times \times - \triangle \blacksquare$

O - Year (0 for 2000, 1 for 2001)

□ - Month (1 for Jan., 9 for Sep., A for Oct., B for Nov.)

 $\times \times \times \times$ - Nichia's Product Number

 \triangle - Ranking by Color Coordinates

Ranking by Luminous Intensity

^{**} Measurement Uncertainty of the Peak Wavelength: ±3nm

^{***} One delivery will include three different ranks of products. The quantity-ratio of the three ranks is decided by Nichia.

6.RELIABILITY

(1) TEST ITEMS AND RESULTS

| | Standard | | | Number of |
|-------------------------|-------------|---|---------------|-----------|
| Test Item | Test Method | Test Conditions | Note | Damaged |
| Resistance | JIS C 7021 | Tsol= 260 ± 5 °C, 10 sec. | 1 time | 0/100 |
| to Soldering Heat | (1977)A-1 | (3mm from the base of the epoxy bulb) | | |
| Solderability | JIS C 7021 | Tsol= 235 ± 5 °C, 5sec. | 1 time | 0/100 |
| | (1977)A-2 | (using flux) | over 95% | |
| Heat Shock | JIS C 7021 | 0°C ~ 100°C | 100 cycles | 0/100 |
| | (1977)A-3 | 5sec. 15sec. | | |
| Temperature Cycle | JIS C 7021 | -40°C ~ 25°C ~ 100°C ~ 25°C | 100 cycles | 0/100 |
| | (1977)A-4 | 30min. 5min. 30min. 5min. | | |
| High Humidity | JIS C 7021 | 30°C ~ 65°C ~ -10°C | 10 cycles | 0/100 |
| Heat Cycle | (1977)A-5 | 90%RH 24hrs./1cycle | | |
| Mechanical Strength | JIS C 7021 | Load 2.5N (0.25kgf) | No noticeable | 0/100 |
| of Terminal (bend test) | (1977)A-11 | $0^{\circ} \sim 90^{\circ} \sim 0^{\circ}$ bend 3 times | damage | |
| Mechanical Strength | JIS C 7021 | Load 10N (1kgf) | No noticeable | 0/100 |
| of Terminal (pull test) | (1977)A-11 | 30 ± 1 sec. | damage | |
| High Temperature | JIS C 7021 | Ta=100°C | 1000hrs. | 0/100 |
| Storage | (1977)B-10 | | | |
| Humidity Heat | JIS C 7021 | Ta=60°C, RH=90% | 1000hrs. | 0/100 |
| Load | (1977)B-11 | | | |
| Low Temperature | JIS C 7021 | Ta=-40°C | 1000hrs. | 0/100 |
| Storage | (1977)B-12 | | | |
| Life Test | JIS C 7035 | Ta=25°C, I _F =15mA | 1000hrs. | 0/100 |
| | (1985) | | | |
| High Humidity | | 60°C, RH=90%, I _F =10mA | 500hrs. | 0/100 |
| Heat Life Test | | | | |
| Low Temperature | | Ta=-30°C, I _F =10mA | 1000hrs. | 0/100 |
| Life Test | | | | |

(2) CRITERIA FOR JUDGING THE DAMAGE

| Item | Symbol | Test Conditions | Criteria for Judgement | |
|----------------------|--------|----------------------|------------------------|--------------|
| | | | Min. | Max. |
| Forward Voltage | VF | I _F =10mA | - | U.S.L.*)×1.1 |
| Optical Power Output | Po | I _F =10mA | L.S.L.**)×0.7 | - |

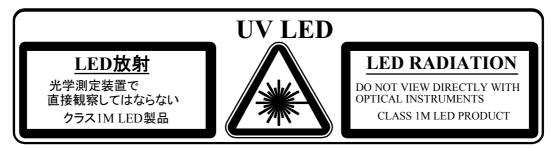
^{*)} U.S.L. : Upper Standard Level

**) L.S.L.: Lower Standard Level

7.CAUTIONS

(1) Cautions

- The devices are UV light LEDs. The LED during operation radiates UV light. Do not look through the optical system.
- · Put label which meets the IEC 60825-1 Amendment 2 standard on the cardboard box.



(2) Lead Forming

- · When forming leads, the leads should be bent at a point at least 3mm from the base of the lead. Do not use the base of the lead as a fulcrum during lead forming.
- · Lead forming should be done before soldering.
- · Do not apply any bending stress to the base of the lead. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- · When mounting the LEDs onto a printed circuit board, the holes on the circuit board should be exactly aligned with the leads of the LEDs. If the LEDs are mounted with stress at the leads, it causes deterioration of the can and this will degrade the LEDs.

(3) Soldering Conditions

- · Solder the LEDs no closer than 3mm from the base of the lead.
- · Maximum Allowable Soldering Conditions

| | Soldering | Solder Dipping | |
|----------------|-------------------------------------|---|--|
| Soldering Iron | : 30W Max. | Pre-Heat : 100°C Max. | |
| | | Pre-Heat Time : 60 seconds Max. | |
| Temperature | : 300°C Max. | Solder Bath Temperature : 260°C Max. | |
| Soldering Time | e: 3 seconds Max. | Dipping Time : 5 seconds Max. | |
| Position | : No closer than 3 mm from the base | Dipping Position: No lower than 3 mm from the | |
| | of the lead. | base of the lead. | |

- · Do not apply any stress to the lead particularly when heated.
- · The LEDs must not be repositioned after soldering.
- · After soldering the LEDs, the glass should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- · Direct soldering onto a PC board should be avoided. Mechanical stress to the resin may be caused from warping of the PC board or from the clinching and cutting of the leads. When it is absolutely necessary, the LEDs may be mounted in this fashion but the User will assume responsibility for any problems. Direct soldering should only be done after testing has confirmed that no damage such as wire bond failure or glass deterioration will occur. Nichia's LEDs should not be soldered directly to double sided PC boards because the heat will deteriorate the glass.
- · When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.
- · Cut the LED leads at room temperature. Cutting the leads at high temperature may cause failure of the LEDs.

(4) Heat Generation

- · Heat generation must be taken into design consideration when using the LEDs. The coefficient of temperature increase per input electric power at room temperature is about 0.75 degrees C/mW at the LED's active layer. This temperature gets higher when the LEDs are densely mounted.
 - It is necessary to design the circuit so that the operating conditions are within the absolute maximum ratings.
- · The operating current should be decided after considering the ambient maximum temperature when the LEDs are illuminating.

(5) Static Electricity

· Static Electricity and surge damages the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

· All devices, equipment and machinery must be properly grounded.

When inspecting own final products on which LEDs were mounted, it is recommended to check also whether the mounted LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by Vf test at lower current.

· Damaged LEDs will show some unusual characteristics such as starting forward voltage becomes lower, or the LEDs get unlighted at the low current.

Test method : (VF > 2.5V at IF=0.5mA)

(6) Cleaning

- · When washing is required, isopropyl alcohol should be used.
- The influence of ultrasonic cleaning on the LEDs differs depending on factors such as oscillator output and how the LEDs are mounted. Before cleaning by ultrasonic wave, testing should be performed to ensure this will not cause damage to the LEDs.

(7) Safety Guideline for Human Eyes

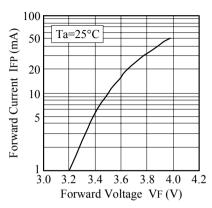
· In 1993, International Electric Committee issued a standard "IEC 825-1" which is related to the safety of Laser products. This standard is also applicable Light Emitting Diode. Since the issuance of "IEC 825-1", it had been examined to ease the control of diffused light source. As the result of the review, a new measuring method, which cares the size of the light source, was introduced with "IEC 60825-1 Edition 1.1" in 1998. Also Laser products were categorized into seven classes with "IEC 60825-1 Amendment 2" in 2001. These standards are subject only to final products and excluding assembled parts for the final products. According to "IEC 60825-1 Amendment 2", most of individual visible-LED is classified as "Class 1" and UV LED is classified as "Class 1M". The class of LEDs depends on light output power and/or viewing angle and some visible-LEDs with higher output power or narrow viewing angle might be categorized as "Class 2".

There is a possibility to give damage to your eyes if you directly watch LEDs when the LEDs are emitting higher output power or the emitted light is intensified by optical equipment.

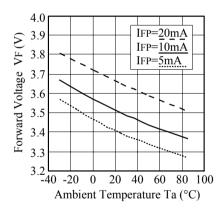
According to the light output power of the final products, you need to put labels which meet the IEC standard.

(8) Others

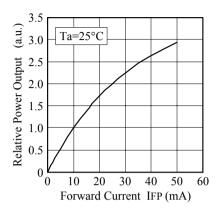
- The leads are plated with gold. They will become discolored by contact with hydrogen sulfide and other gaseous chemicals. Precautions must be taken to maintain a clean storing atmosphere. Also, if the LEDs are stored for 3 months or more after being shipped from Nichia, a sealed container with a nitrogen atmosphere should be used for storage.
- These LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult Nichia's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
- · User shall not reverse engineer by disassembling or analysis of the LEDs without having the prior written consent of Nichia. When defective LEDs are found, User shall inform to Nichia directly before disassembling or analysis.
- · The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- The appearance and specifications of the product may be modified for improvement without notice.



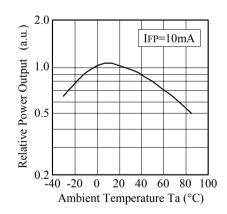
■ Ambient Temperature vs. Forward Voltage



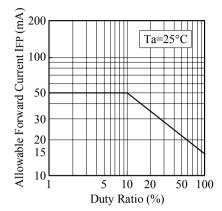
■ Forward Current vs. Relative Power Output



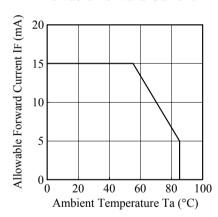
■ Ambient Temperature vs. Relative Power Output



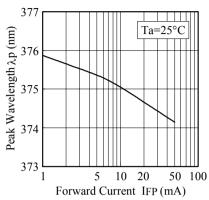
■ Duty Ratio vs. Allowable Forward Current



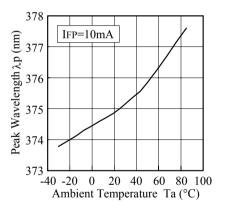
■ Ambient Temperature vs. Allowable Forward Current



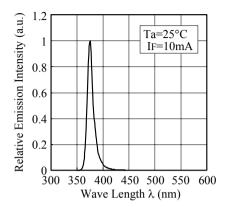
Model **NSHUxxx** NICHIA CORPORATION Title TYP.CHARACTERISTICS 010402101811 No.



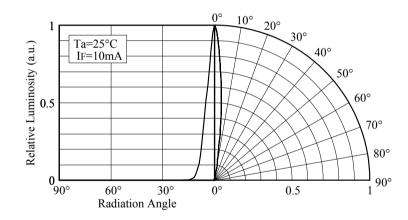
■ Ambient Temperature vs. Peak Wavelength



■ Spectrum



■ Directivity (NSHU590)

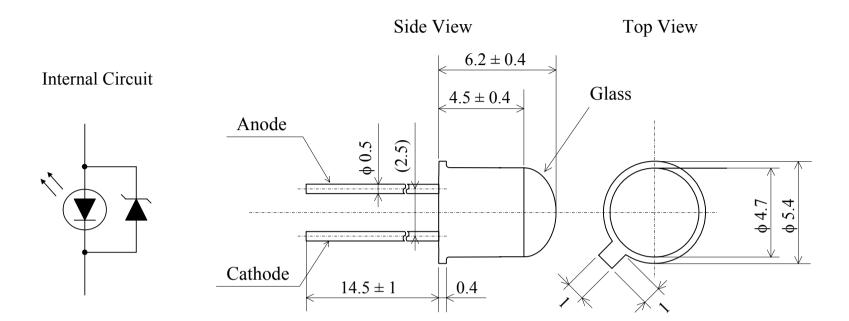


NICHIA CORPORATION Title TYP.CHARACTERISTICS

Model

No. 010402101831

NSHU590



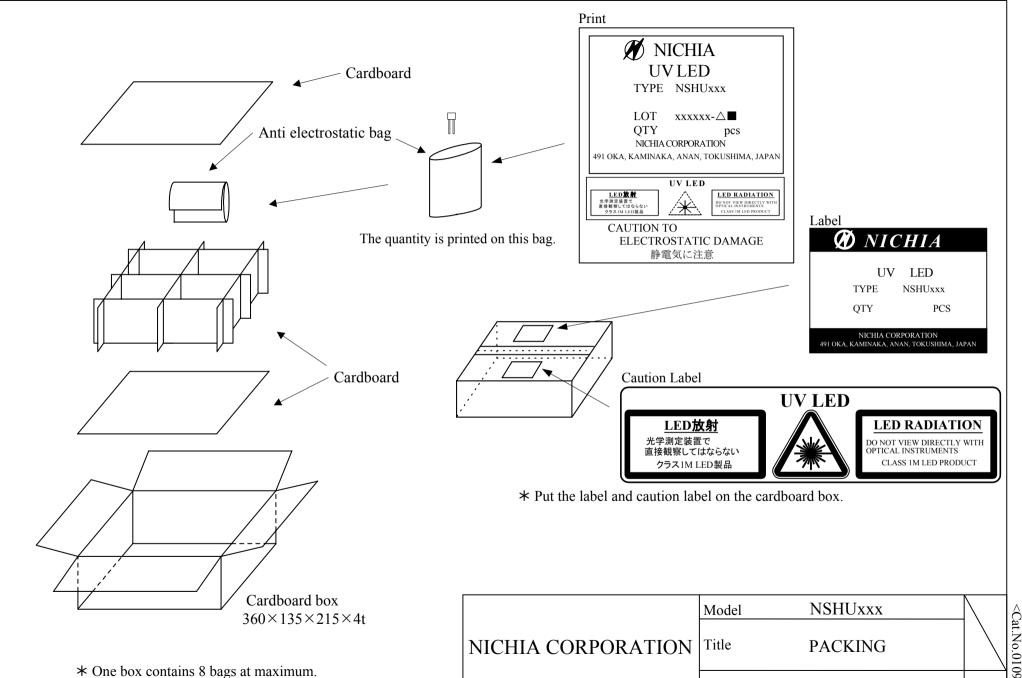
* NSHU590 has a zener diode built in as a protection circuit against static electricity.

| ITEM | MATERIALS | | | |
|-------|-----------------------|--|--|--|
| GLASS | Hard Glass | | | |
| CAP | Ni Plating Iron Alloy | | | |
| LEAD | Au Plating Iron Alloy | | | |

| | | | | , |
|--------------------|-------|--------------------|---------------|-------------------------|
| NICHIA CORPORATION | Model | NSHU590 | Unit | ST <c;< td=""></c;<> |
| | Title | OUTLINE DIMENSIONS | 10/1 Scale | CE-CH00 at.No.010 |
| | No. | 010903106161 | Allow ±0.2 |)22B 903> |

Nichia



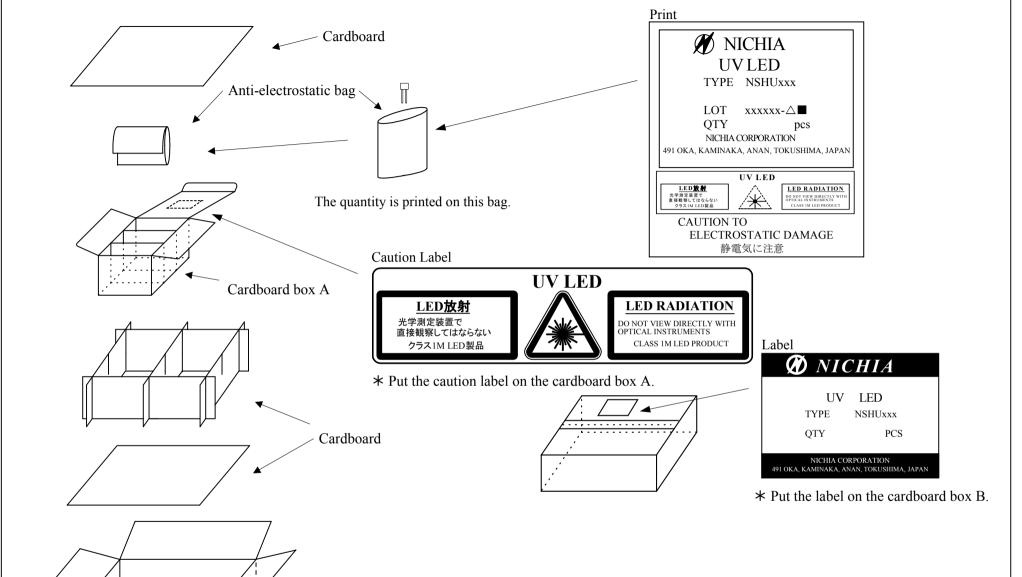


Nichia STCE-CH0022B <Cat.No.010903>

010825101993

No.





Cardboard box B

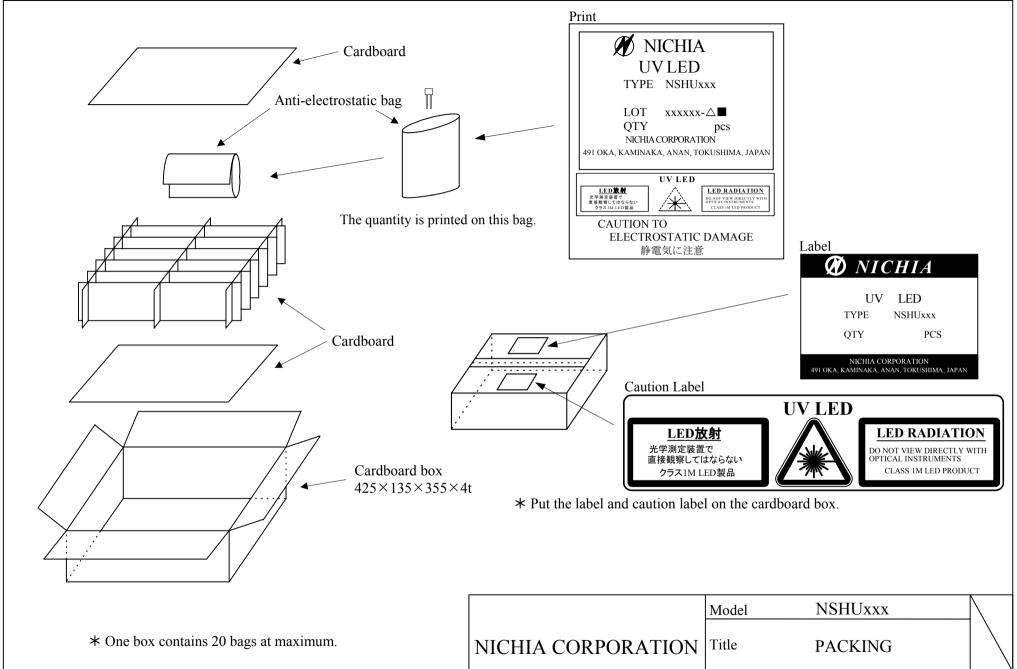
* The cardboard box B contains

2 cardboard box A at maximum.

 $360 \times 135 \times 215 \times 4t$

| | Model | NSHUxxx | |
|--------------------|-------|--------------|--|
| NICHIA CORPORATION | Title | PACKING | |
| | No. | 010825102003 | |

Nichia STCE-CH0022B <Cat.No.010903>

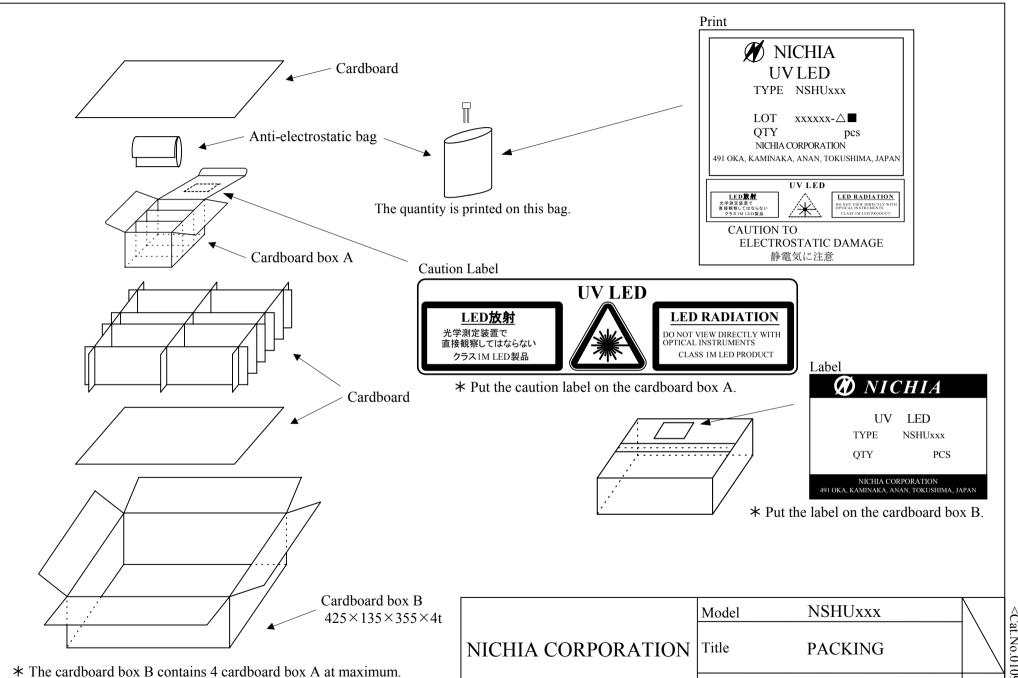


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